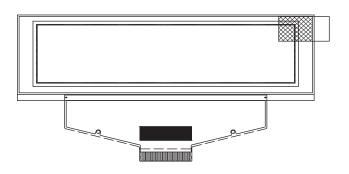


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256 x 64 Graphic OLED



MECHANICAL DATA						
ITEM	STANDARD VALUE	UNIT				
Module dimension	88.0 x 27.8 x 2.05					
Viewing area	78.78 x 21.18					
Active area	76.778 x 19.178	mm				
Dot size	0.278 x 0.278	mm				
Dot pitch	0.300 x 0.300					
Mounting hole	n/a					

FEATURES

Type: graphic

• Display format: 256 x 64 dots

Built-in controller: SSD1322Duty cycle: 1/64

• +3 V power supply

• Interface: I²C, 4-wire SPI, 6800, 8080

Without polarizer

Material categorization: for definitions of compliance

COMPLIANT

please see www.vishay.com/doc?99912

ABSOLUTE MAXIMUM RATINGS							
ITEM	SYMBOL	STANDAF	UNIT				
IIEWI	STIVIDOL	MIN.	MAX.	UNII			
Supply voltage for operation (1)(2)	V _{CI}	-0.3	4	V			
Supply voltage for logic (1)(2)	V_{DD}	-0.5	2.75	V			
Supply voltage for I/O pins (1)(2)	V _{DDI/O}	-0.5	V _{CI}	V			
Supply voltage for display (1)(2)	V _{CC}	-0.5	20	V			
Operating temperature	T _{OP}	-40	+80	°C			
Storage temperature	T _{STG}	-40	+80				

Notes

 $^{(1)}$ All the above voltages are on the basis of " $V_{SS} = 0 V$ "

(2) When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate

ELECTRICAL CHARACTERISTICS							
ITEM	CVMDOL	CONDITION	ST	ANDARD VAL	.UE	LINUT	
IIEM	SYMBOL CONDITION —	MIN.	TYP.	MAX.	UNIT		
Supply voltage for logic	V _{CI}	(1)	2.8	3.0	3.3		
Supply voltage for display	V _{CC}	=	14	14.5	15		
High level input	V _{IH}	=	0.8 V _{DD}	-	V _{DDI/O}	v	
Low level input	V_{IL}	=	0	-	0.2 V _{DDI/O}	V	
High level output	V _{OH}	=	0.9 V _{DDI/O}	-	V _{DDI/O}		
Low level output	V_{OL}	=	0	-	0.1 V _{DDI/O}		
50 % check board operating current	I _{DD}	V _{CC} = 14.5 V	23	25	32	mA	

Note

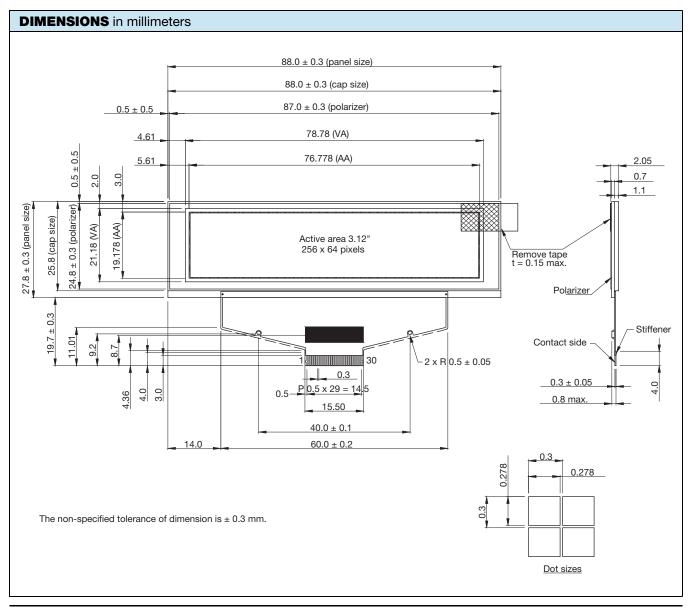
Supply voltage for logic = V_{DD} core power supply can be regulated from V_{CI}

OPTIONS				
		EMITTING COLOR		
YELLOW	GREEN	RED	BLUE	WHITE
Yes	-	-	-	-



	ACE PIN F		JN T					
PIN NO.	SYMBOL	I/O		FUNCTION				
POWER SI	UPPLY	1						
26	V _{CI}	Р	Power supply for operation This is a voltage supply pin. It must than V _{DD} and V _{DDI/O}	be connected to external soul	rce and always be equal to or higher			
25	V _{DD}	Р		This is a voltage supply pin. It can be supplied externally (within the range of 2.4 V to 2.6 V) or regulated internally from V_{Cl} . A capacitor should be connected between this pin and V_{SS} under all				
24	V _{DDI/O}	Р	signal should have V _{IH} reference	Power supply for I/O pin This pin is a power supply pin of I/O buffer. It should be connected to V_{DD} or external source. All I/O signal should have V_{IH} reference to $V_{DDI/O}$. When I/O signal pins (BS0 to BS1, D0 to D7, control signals) pull "high", they should be connected to $V_{DDI/O}$				
2	V _{SS}	Р	Ground of logic circuit This is a ground pin. It also acts a ground	s a reference for the logic pin	s. It must be connected to external			
3, 29	V _{CC}	Р	Power supply for OLED panel These are the most positive voltage supply pin of the chip. They must be connected to external source					
5, 28	V _{LSS}	Р	Ground of analog circuit These are the analog ground pins. They should be connected to V _{SS} externally					
DRIVER		I		s, chould be conhected to	- 33 Satornary			
			Current reference for brightness ac	djustment				
22	I _{REF}	I	This pin is segment current reference pin. A resistor should be connected between this pin and V_{SS} Set the current lower than 10 μA					
4	V _{COMH}	Р	Voltage output high level for COM signal This pin is the input pin for the voltage output high level for COM signals. A tantalum capacitor should be connected between this pin and $V_{\rm SS}$					
27	V _{SL}	Р	Voltage output low level for SEG single This is segment voltage reference When external V _{SL} is used, this pin	pin. When external V _{SL} is not	used, this pin should be left open. and diode to ground			
TESTING F	PADS							
21	FR	0	This pin is no connection pins. Not individually	hing should be connected to t	his pin. This pin should be left open			
			Communicating protocol select These pins are MCU interface sele	ction input. See the following	table:			
16	BS0			BS0	BS1			
			3-wire SPI	1	0			
		'	4-wire SPI	0	0			
17	BS1		8-bit 68XX parallel	1	1			
			8-bit 80XX parallel	0	1			
20	RES#	ı	Power reset for controller and drive This pin is reset signal input. When		the chip is executed			
19	CS#	I	Chip select	This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled				
18	D/C#	I	Data / command control This pin is data / command control pin. When the pin is pulled "high", the input at D7 to D0 is treated as display data. When the pin is pulled "low", the input at D7 to D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the timing characteristics diagrams					
14	E/RD#	ı	used as the enable (E) signal. Read CS# is pulled "low". When connect	d / write operation is initiated ting to an 80XX-microprocessated when this pin is pulled "lo	ries microprocessor, this pin will be when this pin is pulled high and the sor, this pin receives the read (RD#) ow" and CS# is pulled "low". When			

INTERFA	CE PIN FU	JNCTIC	ON
PIN NO.	SYMBOL	I/O	FUNCTION
15	R/W#	1	Read / write select or write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as read / write (R/W#) selection input. Pull this pin to "high" for read mode and pull it to "low" for write mode. When 80XX interface mode is selected, this pin will be the write (WR#) input. Data write operation is initiated when this pin is pulled "low" and the CS# is pulled "low". When serial mode is selected, this pin must be connected to VSS
6 to 13	D7 to D0	I/O	Host data input / output bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. Unused pins must be connected to V _{SS} except for D2 in serial mode
RESERVE			
23	NC	-	Reserved pin The NC pin between function pins are reserved for compatible and flexible design
1, 30	NC (GND)	-	Reserved pin (supporting pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground





MODULE CLA	SSIFICATION INFORMA	ATION				
OLED -	256 Y 064 B	- L P P 3 N 0 0 000				
1	2 3 4 5	6 7 8 9 10 11 12 13				
1	Brand	Vishay Intertechnology, Inc.				
2	Horizontal format	256 columns				
		F: COG type, with frame				
		H: graphic type				
3	Display type	N: character type				
		O: COG type				
		Y: tab type				
4	Vertical format	64 lines				
5	Serials code	В				
		A: amber				
		B: blue				
		C: full color				
6		G: green				
	Emitting color	L: yellow				
		R: red				
		S: sky blue				
		W: white				
		X: yellow / sky blue (dual color)				
		Y: yellow green				
7	Polarizer	N: without polarizer P: with polarizer				
		A: active matrix				
8	Display mode	P: passive matrix				
		3: 3.0 V to 3.3 V				
9	Driver voltage	5: 5.0 V				
		N: without touch panel				
10	Touch panel	T: with touch panel				
		0: standard				
		1: sunlight readable				
11	Products type	2: transparent OLED (TOLED)				
		3: flexible OLED				
		4: OLED for lighting				
		0: standard (A level)				
		2: B level				
12	Product grades	3: C level				
		4: high class (AA level)				
		5: customer offerings				
13	Serial number	Application serial number (000 to ZZZ)				



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GENERAL SPE	CIFICATIONS	
ITEM	DIMENSION	UNIT
Dot matrix	256 x 64	
Module dimension	88.0 x 27.8 x 2.05	mm
Viewing area	78.78 x 21.18	mm
Active area	76.778 x 18.178	mm
Dot size	0.278 x 0.278	mm
Dot pitch	0.300 x 0.300	mm
Display mode	Passive matrix	
Display color	Yellow	
Drive duty	1/64	
IC	SSD1322	

FUNCTION BLOCK DIAGRAM

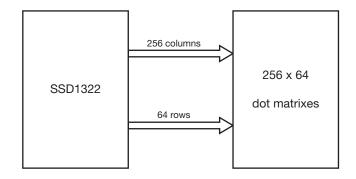
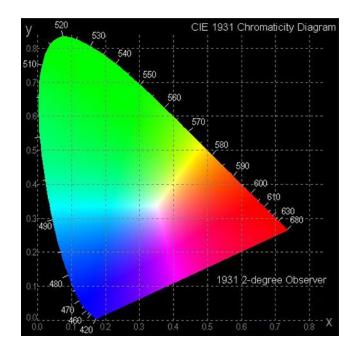


Fig. 1

Note

 For more information, please refer to Application Note provided by Vishay

OPTICAL CHARACTERISTICS							
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	
View andle	(V)θ		160	-	-	.1	
View angle	(H)φ		160	=	-	deg	
Contrast ratio	CR	Dark	2000 : 1	-	-	-	
Deep and time	t _{rise}		-	10	-	μs	
Response time	t _{fall}		-	10	-	μs	
Display with 50 % check board brightness			100	120	-	cd/m ²	
CIE _x (yellow)	(CIE1931)		0.45	0.47	0.49		
CIE _y (yellow)	(CIE1931)		0.48	0.50	0.52		





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OLED LIFETIME			
ITEM	CONDITIONS	MIN.	TYP.
Operating life time	T _A = 25 °C, initial 50 % check board brightness typical value	50 000 h	=

Notes

- Life time is defined the amount of time when the luminance has decayed to < 50 % of the initial value
- This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (PDF) for the product under normal use conditions
- Screen saving mode will extend OLED lifetime

RELABILITY				
ENVIRONMENTAL TEST				
TEST ITEM	(CONTENT OF TEST	Г	TEST CONDITION
High temperature storage	Endurance test appl long time	ying the high stora	ge temperature for a	80 °C, 240 h
Low temperature storage	Endurance test applong time	lying the low storag	ge temperature for a	-40 °C, 240 h
High temperature operation	Endurance test app current) and the ther	olying the electric mal stress to the ele	stress (voltage and ement for a long time	80 °C, 240 h
Low temperature operation	Endurance test ap temperature for a lor		stress under low	-40 °C, 240 h
High temperature / humidity storage	Endurance test app humidity storage for	olying the high ter a long time	mperature and high	60 °C, 90 % RH, 240 h
Temperature cycle	-40 °C 30 min	ying the low and hig 25 °C 5 min 1 cycle	9h temperature cycle 80 °C 30 min	-40 °C / 80 °C, 100 cycles
MECHANICAL TEST				
Vibration test	Endurance test appland using	lying the vibration o	during transportation	10 Hz to 22 Hz for 1.5 mm peak-to-peak, 22 Hz to 500 Hz for 1.5 g, total 0.5 h
Shock test	Constructional and r shock during transpo		nce test applying the	50 g half sin wave 11 ms, 3 times of each direction
Atmospheric pressure test	Endurance test app transportation by air		eric pressure during	115 mbar, 40 h
OTHERS				
Static electricity test	Endurance test appl	ying the electric stre	ess to the terminal	$V_S = \pm~600~V$ (contact), $\pm~800~V$ (air), $R_S = 330~\Omega,~C_S = 150~pF,~10~times$

Note

• Supply voltage for OLED system = operating voltage at 25 °C

TEST AND MEASUREMENT CONDITIONS

- All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hours prior to conducting the failure test at 23 °C ± 5 °C, 55 % ± 15 % RH
- 2. All-pixels-on is used as operation test pattern
- 3. The degradation of polarizer are ignored for high temperature storage, high temperature / humidity storage, temperature cycle

EVALUATION CRITERIA

- 4. The function test is OK
- 5. No observable defects
- 6. Luminance: > 50 % of initial value
- 7. Current consumption: within ± 50 % of initial value

APPENDIX: RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



INSF	PECTION SPECIF	FICATION					
NO.	ITEM		CRITERIO	N		AQL	
01	Electrical testing Black or white	1.2 Missing character, dot or 1.3 Display malfunction 1.4 No function or no display 1.5 Current consumption exc 1.6 OLED viewing angle defect 1.7 Mixed product types 1.8 Contrast defect	1.4 No function or no display1.5 Current consumption exceeds product specifications1.6 OLED viewing angle defect1.7 Mixed product types				
02	spots on OLED (display only)	2.2 Densely spaced: no more			into or black opote present	2.5	
03	OLED black spots, white spots,	3.1 Round type: as following $\Phi = (x + y) / 2$ $\Rightarrow x \qquad y$	drawing	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	ACCEPTABLE QTY Accept no dense 2 1 0	2.5	
	contamination (non-display)	3.2 Line type (as following drawing)	LENGTH - L≤3.0 L≤2.5 -	$\begin{tabular}{c} \textbf{WIDTH} \\ W \le 0.02 \\ 0.02 < W \le 0.03 \\ 0.03 < W \le 0.05 \\ 0.05 < W \\ \end{tabular}$	ACCEPTABLE QTY Accept no dense 2 As round type	2.5	
04	Polarizer bubbles	If bubbles are visible, judge specifications, not easy to fin specify direction.		SIZE Φ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total QTY	ACCEPTABLE QTY Accept no dense 3 2 0 3	2.5	
05	Scratches	Follow no. 3 OLED black spots,	white spots, contami	nation			
06	Chipped glass	Symbols: x: chip length k: seal width l: electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface and z: chip thickness z ≤ 1/2 t 1/2 t < z ≤ 2 t Note	y: chip width t: glass thickness d crack between pane y y: chip width Not over viewing a Not exceed 1/3 k	x y z	z: chip thickness a: OLED side length	2.5	



NO.		EIFICATION				
	ITEM		CRITERION		AQ	
06	Chipped glass	6.1.2 Corner crack:	x z y		2.5	
		z: chip thickness	y: chip width	x: chip length		
		z ≤ 1/2 t	Not over viewing area	x ≤ 1/8 a		
		$1/2 t < z \le 2 t$	Not exceed 1/3 k	x ≤ 1/8 a		
		Note	s, x is total length of each chip	N = 170 %		
		Symbols:	s, x is total length of each emp			
		x: chip length	y: chip width	z: chip thickness		
		k: seal width	t: glass thickness	a: OLED side length		
		I: electrode pad length 6.2 Protrusion over termi 6.2.1 Chip on electrode pa	nal:	a. January		
		z x			1	
		y: chip width	x: chip length	z: chip thickness		
		y ≤ 0.5 mm 6.2.2 Non-conductive porti	x ≤ 1/8 a ion:	0 < z ≤ t		
06	Glass crack	y z		z	2.	
06	Glass crack	V. chip width	v: chin length	z chin thickness	2.8	
06	Glass crack	y : chip width $y \le 1$	x: chip length x ≤ 1/8 a	z : chip thickness $0 < z \le t$	2.5	
06	Glass crack	y ≤ I Notes • If the chipped area touch according to electrode ter	x ≤ 1/8 a es the ITO terminal, over 2/3 of the ITO minal specifications sealed by the customer, the alignment	0 < z ≤ t O must remain and be inspected		





INSPECTION SPECIFICATION						
NO.	ITEM	CRITERION	AQL			
		8.1 Illumination source flickers when lit	0.65			
08	Backlight elements	8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards	2.5			
		8.3 Backlight does not light or color wrong	0.65			
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination	2.5			
09	Бегеі	9.2 Bezel must comply with job specifications	0.65			
		10.1 COB seal may not have pinholes larger than 0.2 mm or contamination	2.5			
		10.2 COB seal surface may not have pinholes through to the IC	2.5			
		10.3 The height of the COB should not exceed the height indicated in the assembly diagram	0.65			
		10.4 There may not be more than 2 mm of sealant outside the seal area on the PCB. And there should be no more than three places	2.5			
10	PCB, COB	10.5 No oxidation or contamination PCB terminals	2.5			
		10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts	0.65			
		10.7 The jumper on the PCB should conform to the product characteristic chart	0.65			
		10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down	2.5			
	Caldaria	11.1 No un-melted solder paste may be present on the PCB	2.5			
11		11.2 No cold solder joints, missing solder connections, oxidation or icicle	2.5			
11	Soldering	11.3 No residue or solder balls on PCB	2.5			
		11.4 No short circuits in components on PCB	0.65			
		12.1 No oxidation, contamination, curves or, bends on interface pin (OLB) of TCP	2.5			
		12.2 No cracks on interface pin (OLB) of TCP	0.65			
		12.3 No contamination, solder residue or solder balls on product	2.5			
		12.4 The IC on the TCP may not be damaged, circuits	2.5			
	General appearance	12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever	2.5			
12		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color	2.5			
		12.7 Sealant on top of the ITO circuit has not hardened	2.5			
		12.8 Pin type must match type in specification sheet	0.65			
		12.9 OLED pin loose or missing pins	0.65			
		12.10 Product packaging must the same as specified on packaging specification sheet	0.65			
		12.11 Product dimension and structure must conform to product specification sheet	0.65			



CHECK ITEM	CLASSIFICATION	CRITERIA
No display	Major	
Missing line	Major	
Wissing line		
Pixel short	Major	
Darker short	Major	
Wrong display	Major	
Un-uniform	Major	
B/A x 100 % < 70 % A/C x 100 % < 70 %		A Normal B Dark pixel C Light pixel

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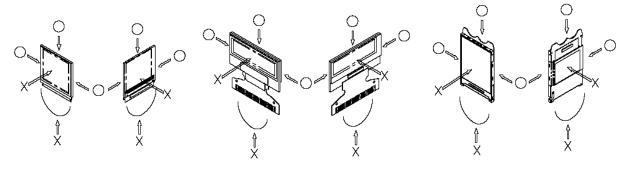
PRECAUTIONS IN USE OF OLED MODULES

MODULES

- 1. Avoid applying excessive shocks to module or making any alterations or modifications to it
- 2. Do not make extra holes on the printed circuit board, modify its shape or change the components of OLED display module
- 3. Do not disassemble the OLED display module
- 4. Do not operate it above the absolute maximum rating
- 5. Do not drop, bend or twist OLED display module
- 6. Soldering: only to the I/O terminals
- 7. Storage: please storage in anti-static electricity container and clean environment
- 8. It is pretty common to use "screen saver" to extend the lifetime and do not use fix information for long time in real application
- 9. Do not use fixed information in OLED panel for long time, that will extend "screen burn" effect time
- 10. Vishay has the right to change the passive components, including R2 and R3 adjust resistors. (Resistors, capacitors, and other passive components will have different appearance and color caused by the different supplier)
- 11. Vishay have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization, and the best product performance... etc, under the premise of not affecting the electrical characteristics and external dimensions, Vishay have the right to modify the version)

HANDLING PRECAUTIONS

- 1. Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position
- 2. If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance
- 3. If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections
- 4. The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module
- 5. When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape
- Scotch mending tape no. 810 or an equivalent
 Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since
 the surface of the polarizer will become cloudy. Also, pay attention that the following liquid and solvent may spoil the
 polarizer:
 - Water
 - Ketone
 - Aromatic solvents
- 6. Hold OLED display module very carefully when placing OLED display module into the system housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases



- 7. Do not apply stress to the LSI chips and the surrounding molded sections
- 8. Do not disassemble nor modify the OLED display module
- 9. Do not apply input signals while the logic power is off

OLED-256Y064B-LPP3N00000

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- 10. Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity
 - Be sure to make human body grounding when handling OLED display modules
 - Be sure to ground tools to use or assembly such as soldering irons

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- To suppress generation of static electricity, avoid carrying out assembly work under dry environments
- Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film
- 11. Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above no. 5
- 12. If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above

STORAGE PRECAUTIONS

- 1. When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps and, also, avoiding high temperature and high humidity environment or low temperature (less than 0 °C) environments. We recommend you to store these modules in the packaged state when they were shipped from Vishay. At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them
- 2. If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above

DESIGNING PRECAUTIONS

- 1. The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen
- 2. To prevent occurrence of malfunctioning by noise, pay attention to satisfy the V_{II} and V_{IH} specifications and, at the same time, to make the signal line cable as short as possible
- 3. We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD) (recommend value: 0.5 A)
- 4. Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices
- 5. As for EMI, take necessary measures on the equipment side basically
- 6. When fastening the OLED display module, fasten the external plastic housing section
- 7. If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module
 - Connection (contact) to any other potential than the above may lead to rupture of the IC

PRECAUTIONS WHEN DISPOSING OF THE OLED DISPLAY MODULES

1. Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations

OTHER PRECAUTIONS

- 1. When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module
- 2. To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules
 - · Pins and electrodes
 - Pattern layouts such as the TCP and FPC
- 3. With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur
 - Design the product and installation method so that the OLED driver may be shielded from light in actual usage
 - Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes

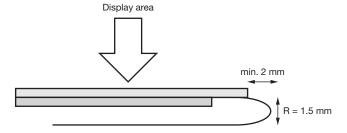
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- 4. Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design
- 5. We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise
- 6. Resistors, capacitors, and other passive components will have different appearance and color caused by the different supplier
- 7. Our company will has the right to upgrade and modify the product function
- 8. The limitation of FPC bending





Legal Disclaimer Notice

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